### 505451318 04/29/2019

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5498119

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

## **CONVEYING PARTY DATA**

Name	Execution Date
YONGCHUN XIAO	04/05/2019
ABHISHEK PRAMOD PATIL	04/04/2019
SANDIP HOMCHAUDHURI	04/17/2019
RAVI GIDVANI	04/07/2019
ALFRED ASTERJADHI	04/04/2019
GEORGE CHERIAN	04/04/2019

## **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED	
Street Address:	5775 MOREHOUSE DRIVE	
City:	SAN DIEGO	
State/Country: CALIFORNIA		
Postal Code:	92121-1714	

## **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	16288025	

## **CORRESPONDENCE DATA**

(281)754-4914 Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2817580025

Email: Imcmillan@deliziolaw.com DELIZIO LAW, PLLC **Correspondent Name:** Address Line 1: 15201 MASON RD. Address Line 2: SUITE 1000-312

Address Line 4: CYPRESS, TEXAS 77433

ATTORNEY DOCKET NUMBER: 181975U1 LINDSAY MCMILLAN NAME OF SUBMITTER: **SIGNATURE:** /Lindsay K. McMillan/ **DATE SIGNED:** 04/29/2019

# Total Attachments: 12 source=181975U1\_Assignment#page1.tif source=181975U1\_Assignment#page2.tif source=181975U1\_Assignment#page3.tif source=181975U1\_Assignment#page4.tif source=181975U1\_Assignment#page5.tif source=181975U1\_Assignment#page6.tif source=181975U1\_Assignment#page7.tif source=181975U1\_Assignment#page8.tif source=181975U1\_Assignment#page9.tif source=181975U1\_Assignment#page10.tif source=181975U1\_Assignment#page11.tif source=181975U1\_Assignment#page12.tif

WHEREAS, WE,

- 1. Yongchun XIAO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 2. **Abhishek Pramod PATIL**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714,**
- 3. Sandip HOMCHAUDHURI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 4. Ravi GIDVANI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 5. **Alfred ASTERJADHI**, having a mailing address located at **5775 Morehouse Drive**, **San Diego**, **CA 92121-1714**,
- 6. **George CHERIAN**, having a mailing address located at **5775 Morehouse Drive**, **San Diego**, **CA 92121-1714**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **CONDITIONAL INHERITANCE IN MANAGEMENT FRAME FOR MULTIPLE BASIC SERVICE SETS** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/288,025 filed February 27, 2019 Qualcomm Reference No. 181975U1, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/636,287 filed February 28, 2018 Qualcomm Reference No. 181975P1,

together with U.S. Provisional Application No(s). 62/685,904 filed June 15, 2018 Qualcomm Reference No. 181975P2, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at 🗽	M JOSE, (A USA, on / LOCATION	DATE	Yongchun XIAO
	LOCATION	· DAIE	Yongchun XIAO
Done at	, on		
	LOCATION , on	DATE	Abhishek Pramod PATIL
Done at _	, on _		Sandip HOMCHAUDHURI
Done at _	LOCATION _	DATE	Ravi GIDVANI
Done at _	LOCATION , on _		
Done at _	, on	DATE	Coorgo CHEDIAN

WHEREAS, WE,

- 1. Yongchun XIAO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 2. **Abhishek Pramod PATIL**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714,**
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- 5. Alfred ASTERJADHI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 6. George CHERIAN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **CONDITIONAL INHERITANCE IN MANAGEMENT FRAME FOR MULTIPLE BASIC SERVICE SETS** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/288,025 filed February 27, 2019 Qualcomm Reference No. 181975U1, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/636,287 filed February 28, 2018 Qualcomm Reference No. 181975P1,

together with U.S. Provisional Application No(s). 62/685,904 filed June 15, 2018 Qualcomm Reference No. 181975P2, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
	LOCATION , on	DATE	Yongchun XIAO
Done at	LOCATION , on	La   4   19 DATE	Abhishek Pramod PATIL
Done at	, on LOCATION	DATE	Sandip HOMCHAUDHURI
Done at	, on LOCATION	DATE	Ravi GIDVANI
Done at	SAN DIEGO, on LOCATION	<u>04/04/10/3</u> DATE	Alfred ASTERJADHI
Done at	LOCATION, on	4/4//5 ' DATE	George CHERIAN

WHEREAS, WE,

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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **CONDITIONAL INHERITANCE IN MANAGEMENT FRAME FOR MULTIPLE BASIC SERVICE SETS** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/288,025 filed February 27, 2019 Qualcomm Reference No. 181975U1, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/636,287 filed February 28, 2018 Qualcomm Reference No. 181975P1,

together with U.S. Provisional Application No(s). **62/685,904** filed **June 15, 2018** Qualcomm Reference No. **181975P2,** (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	LOCATION, on	DATE	Yongchun XIAO
Done at	, on	DATE	Abhishek Pramod PATIL
Done at	SAN SUSE, CA, on LOCATION	4 17 19 DATE	Sandip HOMCHAUDHURI
Done at	, on	DATE	Ravi GIDVANI
Done at	LOCATION on	DATE	Alfred ASTERJADHI
Done at	, on _	DATE	George CHERIAN

WHEREAS, WE.

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together with U.S. Provisional Application No(s). **62/685,904** filed **June 15, 2018** Qualcomm Reference No. **181975P2,** (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

# PATENT QUALCOMM Ref. No. 181975U1 Page 3 of 3

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Done at _	, on		
	LOCATION	DATE	Yongchun XIAO
			Abhishek Pramod PATIL
Done at _	LOCATION , on	DATE	Sandip HOMCHAUDHURI
	Dun Jose, on LOCATION		200
			Alfred ASTERJADHI
	LOCATION , on	DATE	George CHERIAN

PATENT REEL: 049025 FRAME: 0791

RECORDED: 04/29/2019